

HSF

NOTES:

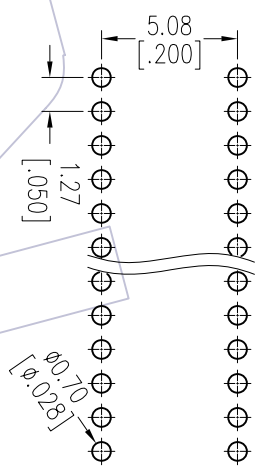
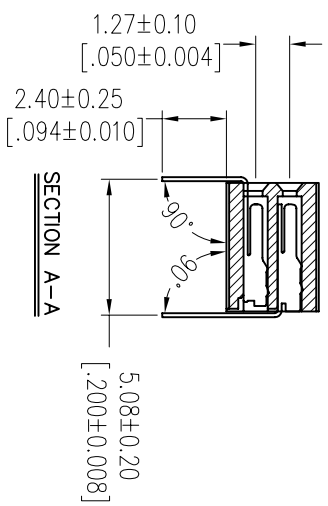
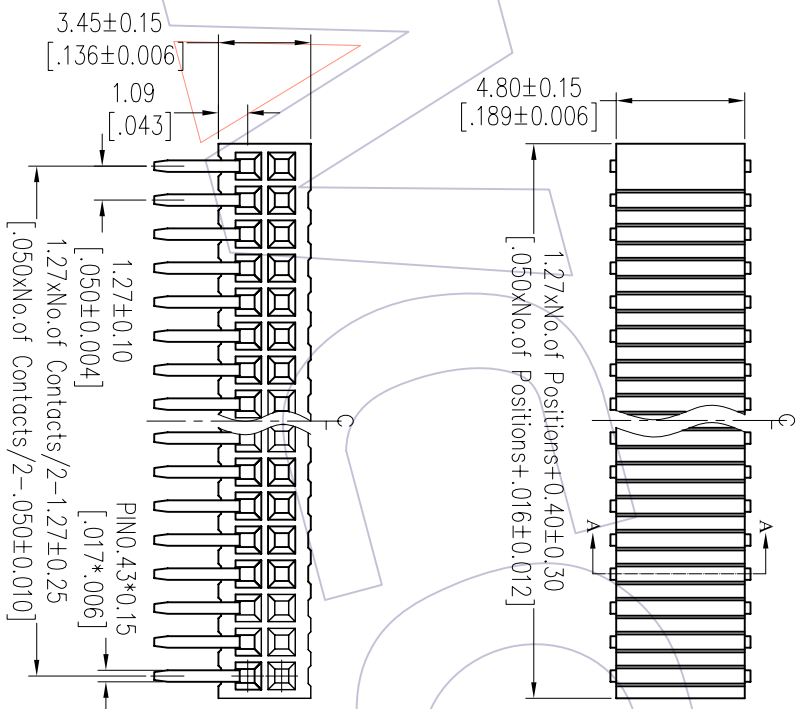
- Current Rating: 1.0AMP
- Contact Resistance: 20mΩ Max
- Withstand Voltage: 500V AC/DC
- Insulation Resistance: 1000MΩ Min
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact plating: Au over Ni
- Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

2335-2 XX R XX CUN T 1

Near Pins per Row: 02-50Pin
 Contact Plating: GP=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold

Packaging: T=Tube



Recommended P.C.B. Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

Item	Pitch	Mating
Standard	1.27	1310/1315/1320
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012/07/07	NEW	

OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
XX	JYHuog	2012/07/07	mm		2335-2XXXXXCUNTT1
XX	CHECK	DATE	UNIT		TITLE:
X.XXX			A4		FH1.27 DUAL SIDE INSERT 90°
Angle	APPROVE	DATE	SHEET		H=3.45
± 3'			1/1		Customer NO.
DIM	TOL		PROJ.		

WCON

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